

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yoshito Ikeda	08/27/2007
Hironobu Moriyama	08/27/2007
Yasuhiro Fujita	08/27/2007

RECEIVING PARTY DATA

Name:	Sony Chemical & Information Device Corporation
Street Address:	Gate City Osaki East Tower 8F, 1-11-2, Osaki, Shinagawa-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	141-0032

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11776933

CORRESPONDENCE DATA

Fax Number: (312)827-8185

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Correspondent Name: Thomas C. Basso

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ATTORNEY DOCKET NUMBER:

117125-006

NAME OF SUBMITTER:

Thomas C. Basso

Total Attachments: 5

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ASSIGNMENT

WHEREAS, the undersigned, to wit: Yoshito Ikeda, Hironobu Moriyama, and Yasuhiro Fujita (hereinafter "ASSIGNORS"), are the lawful owners of an invention entitled: BATTERY PACKS, for which a patent application of the United States will be filed in the United States Patent and Trademark Office or was filed on July 12, 2007 in the United States Patent and Trademark Office having Application Serial No. 11/776,933;

AND WHEREAS, Sony Chemical & Information Device Corporation (hereinafter "ASSIGNEE"), a corporation duly organized and existing under the laws of Japan and having its principal office and place of business at Gate City Osaki East Tower 8F, 1-11-2, Osaki, Shinagawa-ku, Tokyo, 141-0032 Japan, desires to acquire the entire right, title, and interest therein;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, said ASSIGNORS do hereby sell, assign, and transfer, and hereby set over unto ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest to said invention in the United States of America and all foreign countries, including, without limitation, said invention as described in the aforesaid application, to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by said ASSIGNORS had this assignment and sale not been made, including, without limitation, all rights to the aforesaid application and to any United States Letters Patent therefor, when issued together with all improvements thereon and betterments thereof, all related applications including, but not limited to, divisions, continuations, continuations-in-part, reissues and reexaminations thereof and substitutions of or for said application, and all foreign rights including the right to make application for Letters Patent for said inventions in any and all foreign countries and the right to claim priority as to the filing date under the International Convention on the basis for the aforesaid application for United States Letters Patent; and ASSIGNORS hereby authorize and request the Commissioner of Patents to issue all Letters Patent issuing therefrom to ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives.

ASSIGNORS hereby agree to execute any papers, provide any information and testify in any interference or litigation at the request of ASSIGNEE, its successors, assigns and legal representatives, when deemed essential to ASSIGNEE's, its successors', assigns' and legal representatives' full enjoyment, protection, enforcement and title in and to such invention and rights hereby transferred.

ASSIGNORS furthermore agree upon request of said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, to execute any and all papers desired by said ASSIGNEE, its successors, assigns and legal representatives, for the filing and granting of foreign applications and the perfecting of title thereto in said ASSIGNEE, its successors, assigns and legal representatives.

06-3046

Atty. Docket No. 117125-006

It is hereby authorized that the attorney of record in the above-referenced patent application insert the serial number and filing date of the patent application, if applicable, in the spaces identified above.

Signature

Date Signed

Yoshito Ikeda
Name: Yoshito Ikeda

August, 27th, 2007

Address: c/o Sony Chemical & Information Device Corporation
Kanuma Jigyousho, 1078, Kamiishikawa, Kanuma-shi
Tochigi 322-8503 Japan

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Date Signed

Takashi Murayama
Takashi Murayama

Aug. 27, 2007

Signature

Date Signed

Hironobu Moriyama
Name: Hironobu Moriyama

August, 27th, 2007

Address: c/o Sony Chemical & Information Device Corporation
Kanuma Jigyousho, 1078, Kamiishikawa, Kanuma-shi
Tochigi 322-8503 Japan

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Signature

Date Signed

Takashi Murayama
Takashi Murayama

Aug. 27, 2007

Signature

Date Signed

Yasuhiro Fujita

August, 27th, 2007

Name: Yasuhiro Fujita

Address: c/o Sony Chemical & Information Device Corporation
Kanuma Jigyousho, 1078, Kamiishikawa, Kanuma-shi
Tochigi 322-8503 Japan

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Takashi Murayama
Takashi Murayama

Aug. 27, 2007